ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	PC, Bannockt	ourn, Illinois. A	ll rights reserved utions.	under both leve	is docume el parts, tl	ent is a declara he declaration	ation of the s	substances es all lowe	within the manufact er level materials for	urer listed which the	item. Note manufactu	e: if the item is a arer has engineer	n assembly with low ing responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Thtp://www.ipc.org/IPC-175x Distrib				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				erials and l	als and Mfg Information				
Supplier Information														
Company name*	Company unique ID			τ	Unique ID Authority				Respo	Response Date*				
semi								2024-0	2024-05-17					
Contact Name	tet Name Title - Contact				1	Phone - Contact*				Email	Email - Contact*			
oduct-Env-Stewards Product Enviro Complianc			ro Compliance		NA			Produ	Product-Env-Stewards@onsemi.com					
thorized Representative* Title - Representative			entative	Phone -			Representative*			Email	Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number Mfr Item Name				Effective Da	te Version	on Manufacturing Site			Weight*	UOM	Unit Type	
	NCP718	CP718AMT500TBG 300 mA Low Iq, WDFN6		Wide Input Voltage	LDO -	2024-05-17			TH6		9.6	mg	Each	
Aanufacturing Proccess Informa	tion													
Terminal Plating / Grid Array Ma	y Material Terminal Base Alloy		J-STD-020 MSL Ra	ating	Peak Pro	rocess Body Temperature Max Time at Peak		ık Temper	Temperature Number of Reflow Cycle		Cycles			
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	seco	onds 3				
omments														
vel 1 - maximum time at peak temperatu	re during sol	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.4	mg	Supplier	Silicon (Si)	7440-21-3		0.4	mg
Die Attach	0.1	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.006	mg
			Supplier	Silver (Ag)	7440-22-4		0.0815	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.006	mg
			Supplier	Misc.	Proprietary Data		0.0005	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.006	mg
Lead Frame	4.22	mg	Supplier	Tin (Sn)	7440-31-5		0.0105	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0093	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0105	mg
			Supplier	Copper (Cu)	7440-50-8		4.1896	mg
Mold Compound-Black	4.65	mg		Epoxy resin	proprietary data		0.2325	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1069	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2325	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0186	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1069	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.9525	mg
Plating	0.2	mg	Supplier	Tin (Sn)	7440-31-5		0.2	mg
Wire Bond - Au	0.03	mg	Supplier	Gold (Au)	7440-57-5		0.03	mg